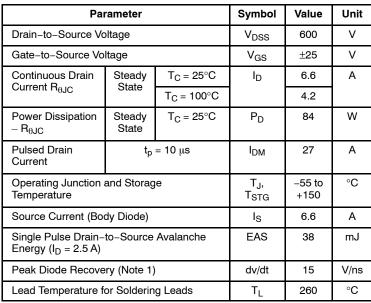
N-Channel Power MOSFET 600 V, 745 m Ω

Features

- 100% Avalanche Tested
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



ABSOLUTE MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $I_{SD} < 6.6 \text{ A}, \text{ di/dt} \le 400 \text{ A/}\mu\text{s}, \text{ V}_{DS \text{ peak}} \le \text{V}_{(BR)DSS}, \text{ V}_{DD} = 80\% \text{ V}_{(BR)DSS}$

THERMAL RESISTANCE

Paramete	Symbol	Value	Unit	
Junction-to-Case (Drain)	NDD60N745U1	$R_{\theta JC}$	1.5	°C/W
	y State NDD60N745U1 NDD60N745U1-1 IDD60N745U1-35	$R_{ heta JA}$	47 98 95	°C/W

2. Insertion mounted

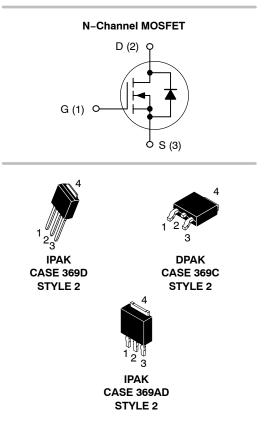
3. Surface mounted on FR4 board using 1" sq. pad size (Cu area = 1.127 in sq [2 oz] including traces)



ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX
600 V	745 mΩ @ 10 V



ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Test Conditions	6	Min	Тур	Max	Unit
OFF CHARACTERISTICS					-	-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA		600			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				540		mV/°C
Drain-to-Source Leakage Current	I _{DSS}	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	$T_J = 25^{\circ}C$			1	μA
			T _J = 125°C			100	1
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = ±20 V				±100	nA
ON CHARACTERISTICS (Note 4)						-	
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250$	Ο μΑ	2	3.2	4	V
Negative Threshold Temperature Co- efficient	V _{GS(TH)} /T _J	Reference to 25°C, $I_D = 250 \mu A$			7.6		mV/°C
Static Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 3.25 A			610	745	mΩ
Forward Transconductance	9FS	V _{DS} = 15 V, I _D = 3.2	25 A		5.6		S
DYNAMIC CHARACTERISTICS					-	-	
Input Capacitance	C _{iss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz			440		pF
Output Capacitance	C _{oss}				27		1
Reverse Transfer Capacitance	C _{rss}				1.5		1
Effective output capacitance, energy related (Note 6)	C _{o(er)}	V_{GS} = 0 V, V_{DS} = 0 to 480 V			21		
Effective output capacitance, time related (Note 7)	C _{o(tr)}	I_D = constant, V_{GS} = 0 V, V_{DS} = 0 to 480 V			71		
Total Gate Charge	Qg				15		nC
Gate-to-Source Charge	Q _{gs}	V_{DS} = 300 V, I _D = 6.8 A, V _{GS} = 10 V			2.9		1
Gate-to-Drain Charge	Q _{gd}				7.3		
Plateau Voltage	V _{GP}				5.3		V
Gate Resistance	R _q				4.4		Ω
RESISTIVE SWITCHING CHARACTER	ISTICS (Note 5))			•		
Turn-on Delay Time	t _{d(on)}				8		ns
Rise Time	t _r	V _{DD} = 300 V, I _D = 6.	8 A.		10		1
Turn-off Delay Time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 0 \Omega$			19		1
Fall Time	t _f				7		1
SOURCE-DRAIN DIODE CHARACTER					•		
Diode Forward Voltage	V _{SD} I _S = 6.6 A, V		$T_J = 25^{\circ}C$		0.90	1.6	V
		$I_{\rm S}$ = 6.6 A, $V_{\rm GS}$ = 0 V	T _J = 100°C		0.82		1
Reverse Recovery Time	t _{rr}	V _{GS} = 0 V, V _{DD} = 30 V I _S = 6.8 A, d _i /d _t = 100 A/µs			260		ns
Charge Time	ta				130		1
Discharge Time	t _b				130		1
					1		+

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2.1

uC

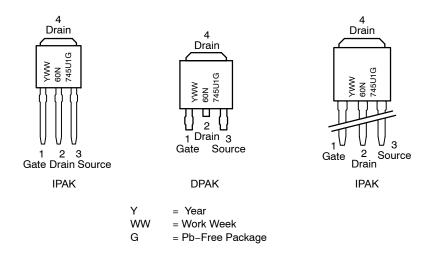
Reverse Recovery Charge

Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

Qr

6. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$ 7. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$

MARKING DIAGRAMS

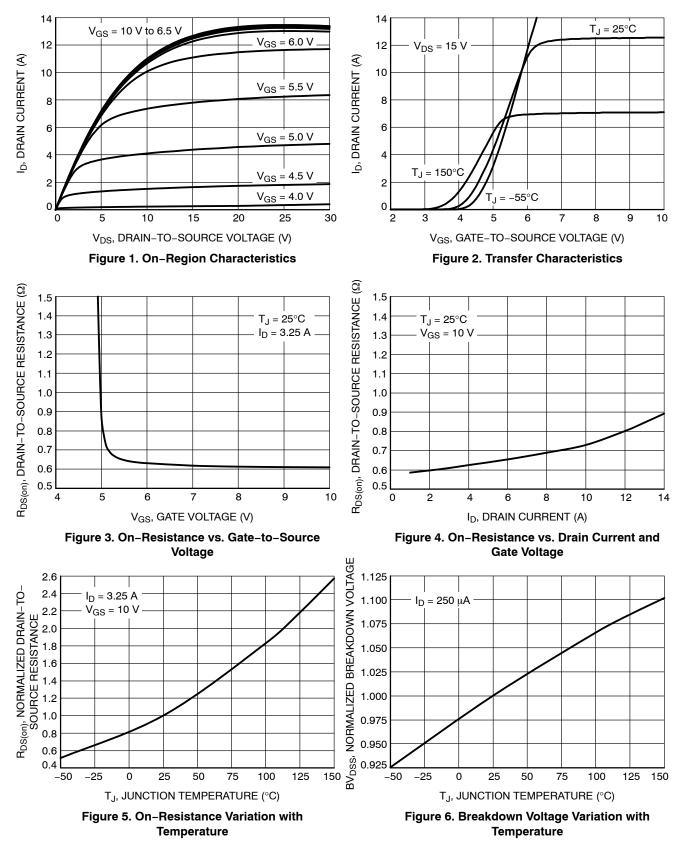


ORDERING INFORMATION

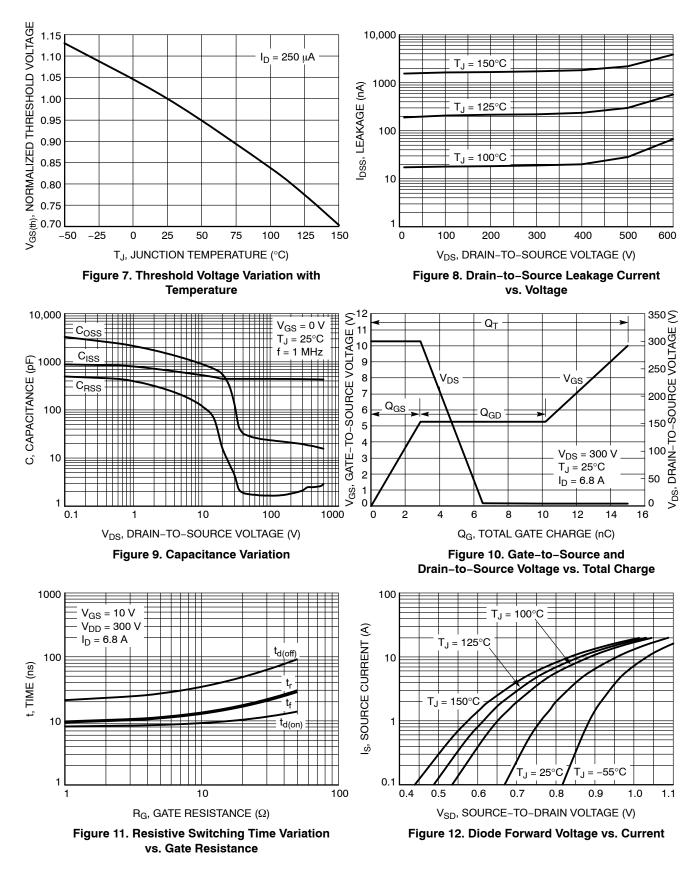
Device	Package	Shipping [†]
NDD60N745U1-1G	IPAK (Pb-Free, Halogen-Free)	75 Units / Rail
NDD60N745U1-35G	IPAK (Pb-Free, Halogen-Free)	75 Units / Rali
NDD60N745U1T4G	DPAK (Pb-Free, Halogen-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

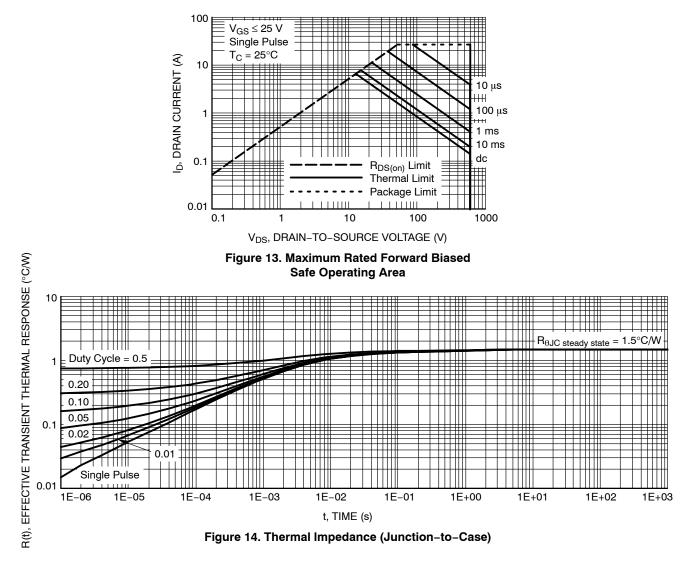
TYPICAL CHARACTERISTICS



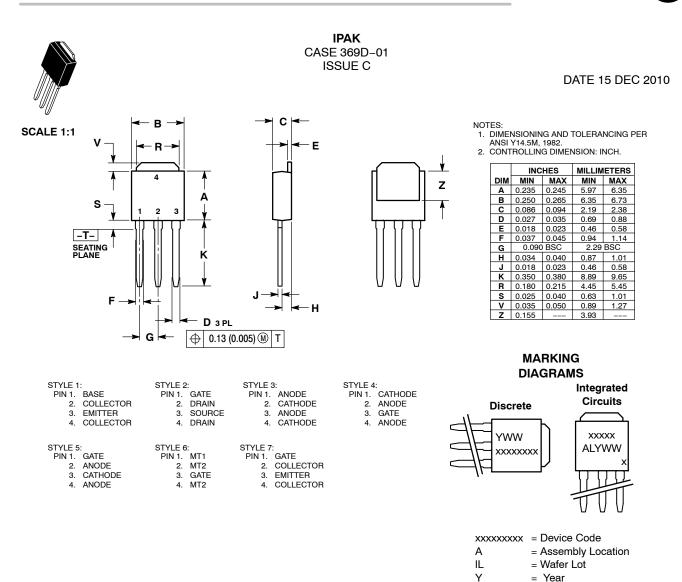
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



ON



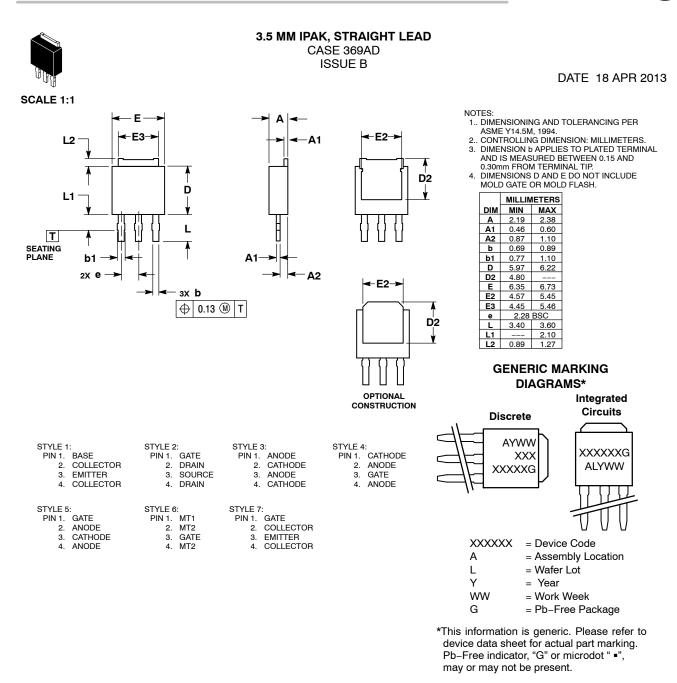
DOCUMENT NUMBER:	98AON10528D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	: IPAK (DPAK INSERTION MOUNT) PAGE		PAGE 1 OF 1	
ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the				

WW

= Work Week

rights of others.





DOCUMENT NUMBER:	98AON23319D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	3.5 MM IPAK, STRAIGHT L	GHT LEAD PAGE 1 OF		
ON Semiconductor and ()) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its part rights nor the				

rights of others.





ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights for the res.

© Semiconductor Components Industries, LLC, 2018

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B